

**2nd IEEE - INTERNATIONAL CONFERENCE
ON
MICROWAVE, ANTENNA AND COMMUNICATION**

MAC2024

(Industry-Academia Conclave)

Co-organized by

**DEAL DRDO, Dehradun,
IIT Roorkee,
THDC IHET Tehri,
&
MNNIT Allahabad**

Conference Venue:

Dehradun, Uttarakhand, India

October 04-06, 2024

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The 2nd IEEE International Conference on Microwave, Antenna and Communication"- MAC 2024 will be held at Dehradun, Uttarakhand, India, during October 04-06, 2024.

The conference aims to offer a platform for researchers, academicians and individuals in the industry and startups to showcase their research innovations, knowledge and vision.

MAC 2024 will include focused track on Young Professionals, Women in Engineering and SIGHT along with technical sessions on recent developments.

For more details visit our website: <https://www.mac2024.org/>

Link for Paper Submission

<https://cmt3.research.microsoft.com/MAC2024/>





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MNNIT Allahabad, Prayagraj, U.P. India



PAPER SUBMISSION

Interested students/researchers/academicians/industry persons can submit their original and previously unpublished work, including specific results. All papers are required to be prepared and submitted in the IEEE Standard two-column conference format of A4 size in English. Papers must be four to six pages in length, including texts, figures, photographs and references. The first page must include the title of the paper, author(s), affiliations, address and text. Please do not include page number on submitted documents. Failing to confirm to the standard format will result in rejection. Detailed format information is available at IEEE Website (<https://www.ieee.org/conferences/publishing/templates.html>). The similarity score of the paper should not be more than 15%.

PAPER UPLOAD

All papers must be submitted in PDF via Microsoft CMT:

<https://cmt3.research.microsoft.com/MAC2024/>

PUBLICATION

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IMPORTANT DATES

Paper Submission Deadline	Early Bird*	April 30, 2024
	Regular	July 31, 2024
Acceptance Notification	Stage I	May 15, 2024
	Stage II	June 15, 2024
	Stage III	August 15, 2024
Camera Ready Paper		September 15, 2024
Registration Deadline		September 15, 2024

*10% of Registration fee will be reimbursed (applicable to only B.Tech/M.Tech students who have registered as first author.)

REGISTRATION FEE (Including 18% GST)

	Category	Indian Delegates	Foreign Delegates
Student Members	IEEE	INR 6900/-	USD 190
	Non-IEEE	INR 9900/-	USD 250
Professional Members	IEEE	INR 12,900/-	USD 290
	Non-IEEE	INR 14,900/-	USD 350

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TRACKS

The Topics of interest include but are not limited to-

Microwave Engineering: Microwave Materials, Circuits, Systems and Applications, Power Amplifier and Circuits, Micro Machined Transformation Lines and Wave Guides, Microwave Device Modelling, Active and Passive Microwave Components, Meta-Materials and Meta Surfaces, Multiband, Broadband Tunable and Reconfigurable Filters, Frequency Selective Surfaces, Filters and Multiplexers, Wireless Power Transfer, Microwave Sensors, Microwave Imaging, High Power Microwave and Microwave Tubes, RF Energy Harvesting and Applications, Slotted and Leaky Wave guides.

Antenna Design: Millimeter Wave, THz Technologies and Systems, Antenna Measurements, Interactions and Coupling, Active, Adaptive and Reconfigurable Antennas, Antennas Array Analysis and Synthesis, Broadband and Multi Band Antenna, HF,VF Antennas and Optical Nano Antenna, Integrated Antenna, Smart Antenna and Digital Beam Forming, Dielectric Resonator Antenna, Antenna Design for Biomedical Applications (Implantable, Wearable etc.), RFID Antenna/Sensors and Systems, Conformal Antenna/Filtenna, MIMO Antenna, RF sensors, Multiband and Wideband Antenna, Antenna for Cubesat, Satellite and Ground Station Applications, Underwater Antenna Design, Phase Array and Beam forming Antenna.

Communication Systems: Space Applications/Satellite Communication, UWB Communication System, Wireless Sensor Networks and Applications, 5G and 6G Wireless Technology, Communication Theory, Communication Networks and Signal Processing, Wireless and Optical Communications, Quantum Communication and Computing, Sensor Networks and Body Area Networks, RADAR Communication, Data Communication Network, Cognitive Radio.

Emerging Technologies and Systems: Machine Learning and AI Technologies, VLSI for communication, GaN HEMT devices, Medical Image Processing, Magnetic Induction (MI) based Communications, MIMO Techniques, Underwater Wireless Communication, Underwater Sensors & Modern Sensor System, IoT Technologies, Energy Harvesting, Green Communication, Molecular Communication.

CONTACT INFORMATION

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